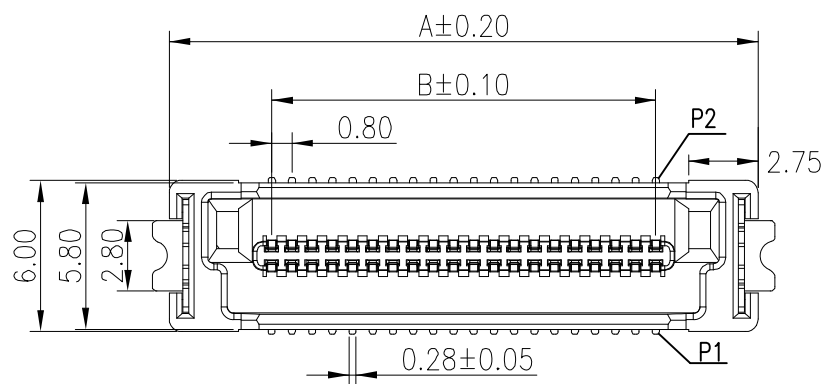
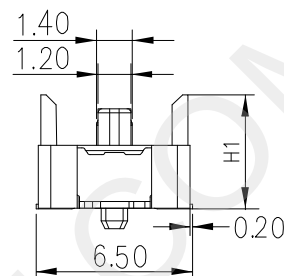
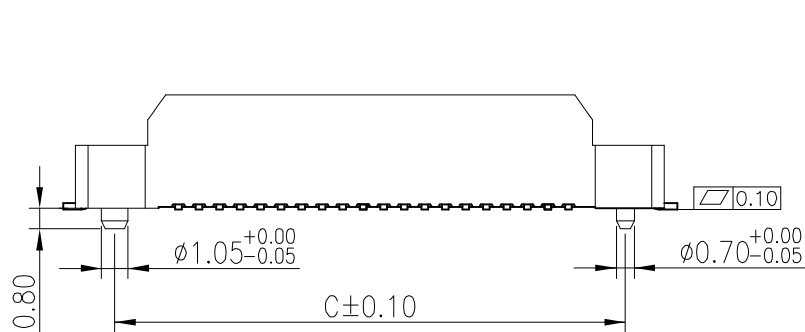
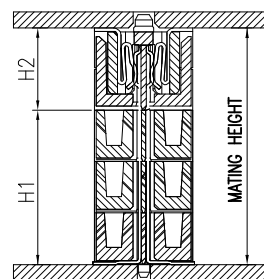
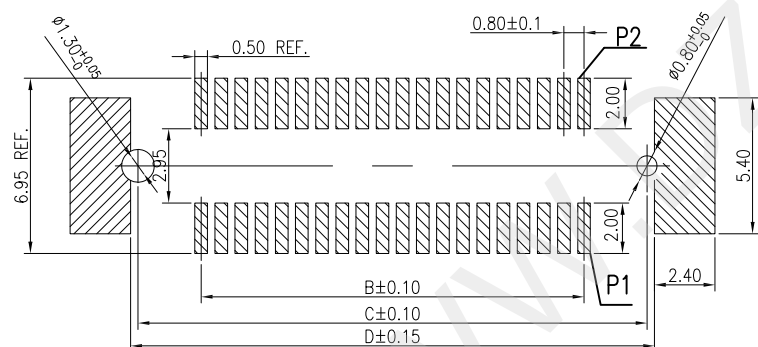


3D VIEW



MATING HEIGHT	H1	H2
5.0	4.5	4.0
8.0	7.5	4.0
10	4.5	9.0
13	7.5	9.0
15	9.5	9.0
18	12.5	9.0
20	14.5	9.0
23	17.5	9.0
25	19.5	9.0

NO.of contacts	Dimensions			
	A.	B.	C.	D.
10	11.3	3.2	8.2	8.8
20	15.3	7.2	12.2	12.8
30	19.3	11.2	16.2	16.8
40	23.3	15.2	20.2	20.8
50	27.3	19.2	24.2	24.8
60	31.3	23.2	28.2	28.8
70	35.3	27.2	32.2	32.8
80	39.3	31.2	36.2	36.8
100	47.3	39.2	44.2	44.8
120	55.3	47.2	52.2	52.8
140	63.3	55.2	60.2	60.8
160	71.3	63.2	68.2	68.8
180	79.3	71.2	76.2	76.8
200	87.3	79.2	84.2	84.8



MATING HEIGHT

NOTES:

1.HUOSING: LCP HIGH-TEMP THERMOPLASTIC UL94V-0 COLOR:BLACK

2.TERMINAL:PHOSPHOR BRONZE

PLATING:GOLD FLASH IN CONTACT AREA/100μ"MIN.MATTE TIN

PLATE IN SOLDER AREA.OVERALL 50μ" MIN. NICKEL.



深圳市华宇创精密电子有限公司

TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME:	
X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X.* ±2* X.X* ±0.5*				0.8PH BTB 公座 金手指带接地片	
 UNIT: mm [inch]		CHECKED BY:	DATE :	PART NO.	HYC18M-BTB2XN-XXX
		马跃	2014-02-23	MOLD NO.	
SCALE:1:1 SIZE: A4		APPROVED BY:	DATE :	DRAW NO:	HYC-2604111848
		邱敏	2014-02-23	SHEET NO.	1 OF 1